- High-Performance Static CMOS Technology
 - 100 MHz (10-ns Cycle Time)
 - Low-Power (1.8-V Core, 3.3-V I/O) Design
 - 3.3-V Flash Voltage
- JTAG Boundary Scan Support[†]
- High-Performance 32-Bit CPU (TMS320C28x)
 - 16 x 16 and 32 x 32 MAC Operations
 - 16 x 16 Dual MAC
 - Harvard Bus Architecture
 - Atomic Operations
 - Fast Interrupt Response and Processing
 - Unified Memory Programming Model
 - Code-Efficient (in C/C++ and Assembly)
- On-Chip Memory
 - F2808: 64-KW Flash, 18-KW SARAM
 F2806: 32-KW Flash, 10-KW SARAM
 F2801: 16-KW Flash, 6-KW SARAM
 - 1K x 16 OTP ROM
- Boot ROM (4K x 16)
 - With Software Boot Modes
 - Standard Math Tables
- Clock and System Control
 - Dynamic PLL Ratio Changes Supported
 - On-Chip Oscillator
 - Clock-Fail-Detect Mode
 - Watchdog Timer Module
- Three External Interrupts (Any GPIO Pin Can Be the Interrupt Source)
- Peripheral Interrupt Expansion (PIE) Block That Supports up to 96 Peripheral Interrupts
- 128-Bit Security Key/Lock
 - Protects Flash/OTP
 - Prevents Firmware Reverse Engineering
- Three 32-Bit CPU-Timers
- Up to 32 Individually Programmable,
 Multiplexed General-Purpose Input/Output (GPIO) Pins

- Enhanced Control Peripherals
 - Up to 16 PWM Outputs
 - Up to Four Capture Inputs
 - Up to Two Quadrature Encoder Interfaces
 - Up to Six 32-bit Timers
 - Up to Six 16-bit Timers
- Serial Port Peripherals
 - Up to 4 Serial Peripheral Interfaces (SPIs)
 - Up to 2 Serial Communications Interfaces (SCIs), Standard UART
 - Up to 2 Enhanced Controller Area Networks (eCANs)
 - One Inter-Integrated-Circuit (I²C) Bus
- 12-Bit ADC, 16 Channels
 - 2 x 8 Channel Input Multiplexer
 - Two Sample-and-Hold
 - Single/Simultaneous Conversions
 - Fast Conversion Rate: 160 ns/6.25 MSPS
- Advanced Emulation Features
 - Analysis and Breakpoint Functions
 - Real-Time Debug via Hardware
- Development Tools Include
 - ANSI C/C++ Compiler/Assembler/Linker
 - Supports TMS320C24x[™]/240x Instructions
 - Code Composer Studio™ IDE
 - DSP/BIOS™
 - JTAG Scan Controllers†
 [Texas Instruments (TI) or Third-Party]
 - Evaluation Modules
 - Broad Third-Party Digital Motor Control Support
- Low-Power Modes and Power Savings
 - IDLE, STANDBY, HALT Modes Supported
 - Disable Individual Peripheral Clocks
- Package Options
 - Thin Quad Flatpack (LQFP) (2808, 2806, 2801)
 - MicroStar BGA (2808, 2806)
- Temperature Options:
 - A: -40°C to 85°C
 - S: -40°C to 125°C



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TMS320C24x, Code Composer Studio, DSP/BIOS, and MicroStar BGA are trademarks of Texas Instruments. † IEEE Standard 1149.1–1990, IEEE Standard Test-Access Port



PRODUCT PREVIEW

SPRS230 - OCTOBER 2003

description

The TMS320F2808, TMS320F2806, and TMS320F2801 devices, members of the TMS320C28x™ DSP generation, are highly integrated, high-performance solutions for demanding control applications.

Throughout this document, TMS320F2808, TMS320F2806, and TMS320F2801 are abbreviated as F2808, F2806, and F2801, respectively.

Table 1 provides a summary of each device's features.

Table 1. Hardware Features

FE.	ATURE	F2808	F2806	F2801
Instruction cycle (at 100 MH	z)	10 ns	10 ns	10 ns
Single-access RAM (SARAM) (16-bit word)		18 kW [†] (L0, L1, M0, M1, H0)	10 kW [†] (L0, L1, M0, M1)	6 kW [†] (L0, M0, M1)
3.3-V on-chip flash (16-bit w	ord)	64 kW	32 kW	16 kW
Code security for on-chip flash		Yes	Yes	Yes
Boot ROM (4K)		Yes	Yes	Yes
One-time programmable (OTP) ROM		Yes	Yes	Yes
External memory interface		_	_	_
Enhanced PWM outputs (six 16-bit timer-based modules with 2 PWM outputs/module)		12	12	6
Enhanced 32-bit CAPTURE inputs or auxiliary PWM outputs		4	4	2
Enhanced 32-bit QEP channels (four inputs/channel)		2	2	1
Watchdog timer		Yes	Yes	Yes
12-Bit ADC		Yes	Yes	Yes
- Channels		16	16	16
32-Bit CPU timers		3	3	3
SPI		4	4	2
SCI		2	2	1
CAN		2	1	1
I ² C		1	1	1
Digital I/O pins (shared)		32	32	32
External interrupts		3	3	3
Supply voltage		1.8-V Core, 3.3-V I/O	1.8-V Core, 3.3-V I/O	1.8-V Core, 3.3-V I/O
Packaging		100 Pin	100 Pin	100 Pin
Temperature options	A: -40°C to 85°C	Yes	Yes	Yes
	S: -40°C to 125°C	Yes	Yes	Yes
Product status		PP	PP	PP

- 4K X 16 each single-access RAM (SARAM) (0 wait-state)

M0 and M1 - 1K X 16 each SARAM (0 wait-state)

H0 - 8K X 16 (1 wait-state).

TMS320C28x is a trademark of Texas Instruments.

All trademarks are the property of their respective owners



IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

Copyright © 2003, Texas Instruments Incorporated